

Insulated Gate Bipolar Transistor Ultralow $V_{CE(on)}$, 342 A

SOT-227

PRODUCT SUMMARY

V_{CES}	600 V
$V_{CE(on)}$ (typical) at 200 A, 25 °C	1.33 V
I_C at $T_C = 97$ °C ⁽¹⁾	200 A
Package	SOT-227

Note

⁽¹⁾ Maximum I_{RMS} current admitted 100 A to do not exceed the maximum temperature of terminals

FEATURES

- Standard: Optimized for minimum saturation voltage and low speed up to 5 kHz
- Lowest conduction losses available
- Fully isolated package (2500 V_{AC})
- Very low internal inductance (5 nH typical)
- Industry standard outline
- UL approved file E78996 
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

RoHS
COMPLIANT

BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, TIG welding, induction heating
- Easy to assemble and parallel
- Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter breakdown voltage	V_{CES}		600	V
Continuous collector current	I_C ⁽¹⁾	$T_C = 25$ °C	342	A
		$T_C = 97$ °C	200	
Pulsed collector current	I_{CM}	Repetitive rating; $V_{GE} = 20$ V, pulse width limited by maximum junction temperature See fig. 15	400	
Clamped Inductive load current	I_{LM}	$V_{CC} = 80\%$ (V_{CES}), $V_{GE} = 20$ V, $L = 10$ μ H, $R_g = 2.0$ Ω , See fig. 14	400	
Gate to emitter voltage	V_{GE}		± 20	V
Reverse voltage avalanche energy	E_{ARV}	Repetitive rating; pulse width limited by maximum junction temperature	155	mJ
RMS isolation voltage	V_{ISOL}	Any terminal to case, $t = 1$ minute	2500	V
Maximum power dissipation	P_D	$T_C = 25$ °C	781	W
		$T_C = 100$ °C	312	
Operating junction and storage temperature range	T_J, T_{Stg}		- 55 to + 150	°C
Mounting torque		6-32 or M3 screw	12 (1.3)	lbf · in (N · m)

Note

⁽¹⁾ Maximum I_{RMS} current admitted 100 A to do not exceed the maximum temperature of terminals

**THERMAL AND MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL		MIN.	TYP.	MAX.	UNITS
Junction and storage temperature range	T_J, T_{STG}		- 55	-	150	°C/W
Thermal resistance, junction to case	R_{thJC}		-	-	0.16	
Thermal resistance case to heatsink	R_{thCS}	Flat, greased surface	-	0.05	-	
Weight			-	30	-	g
Mounting torque			-	-	1.3	Nm
Case style			SOT-227			

ELECTRICAL SPECIFICATIONS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE} = 0\text{ V}, I_C = 250\text{ }\mu\text{A}$	600	-	-	V
Emitter to collector breakdown voltage	$V_{(BR)ECS}^{(1)}$	$V_{GE} = 0\text{ V}, I_C = 1.0\text{ A}$	18	-	-	
Temperature coeff. of breakdown voltage	$\Delta V_{(BR)CES}/\Delta T_J$	$V_{GE} = 0\text{ V}, I_C = 1.0\text{ mA}$	-	0.62	-	V/°C
Collector to emitter saturation voltage	$V_{CE(on)}$	$I_C = 100\text{ A}$	-	1.10	1.3	V
		$I_C = 200\text{ A}$	-	1.33	-	
		$I_C = 100\text{ A}, T_J = 150^\circ\text{C}$	-	1.02	-	
Gate threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C = 250\text{ }\mu\text{A}$	3.0	-	6.0	mV/°C
Temperature coeff. of threshold voltage	$\Delta V_{GE(th)}/\Delta T_J$	$V_{CE} = V_{GE}, I_C = 2\text{ mA}$	-	- 10	-	
Forward transconductance	$g_{fe}^{(2)}$	$V_{CE} = 100\text{ V}, I_C = 100\text{ A}$	90	150	-	S
Zero gate voltage collector current	I_{CES}	$V_{GE} = 0\text{ V}, V_{CE} = 600\text{ V}$	-	-	1.0	mA
		$V_{GE} = 0\text{ V}, V_{CE} = 10\text{ V}, T_J = 150^\circ\text{C}$	-	-	10	
Gate to emitter leakage current	I_{GES}	$V_{GE} = \pm 20\text{ V}$	-	-	± 250	nA

Notes(1) Pulse width $\leq 80\text{ }\mu\text{s}$; duty factor $\leq 0.1\%$ (2) Pulse width $5.0\text{ }\mu\text{s}$, single shot**SWITCHING CHARACTERISTICS** ($T_J = 25^\circ\text{C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Q_g	$I_C = 100\text{ A}$	-	770	1200	nC
Gate emitter charge (turn-on)	Q_{ge}	$V_{CC} = 400\text{ V}$	-	100	150	
Gate collector charge (turn-on)	Q_{gc}	$V_{GE} = 15\text{ V}$; See fig. 8	-	260	380	
Turn-on delay time	$t_{d(on)}$	$T_J = 25^\circ\text{C}$	-	78	-	ns
Rise time	t_r	$I_C = 100\text{ A}$	-	56	-	
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 480\text{ V}$	-	890	1300	
Fall time	t_f	$V_{GE} = 15\text{ V}$	-	390	580	
Turn-on switching loss	E_{on}	$R_g = 2.0\text{ }\Omega$	-	0.98	-	mJ
Turn-off switching loss	E_{off}	Energy losses include "tail"	-	17.4	-	
Total switching loss	E_{ts}	See fig. 9, 10, 13	-	18.4	25.5	
Turn-on delay time	$t_{d(on)}$	$T_J = 150^\circ\text{C}$	-	72	-	ns
Rise time	t_r	$I_C = 100\text{ A}, V_{CC} = 480\text{ V}$	-	60	-	
Turn-off delay time	$t_{d(off)}$	$V_{GE} = 15\text{ V}, R_g = 2.0\text{ }\Omega$	-	1500	-	
Fall time	t_f	Energy losses include "tail"	-	660	-	
Total switching loss	E_{ts}	See fig. 10, 11, 13	-	35.7	-	mJ
Internal emitter inductance	L_E	Between lead, and center of the die contact	-	5.0	-	nH
Input capacitance	C_{ies}	$V_{GE} = 0\text{ V}$	-	16 250	-	pF
Output capacitance	C_{oes}	$V_{CC} = 30\text{ V}$	-	1040	-	
Reverse transfer capacitance	C_{res}	$f = 1.0\text{ MHz}$; See fig. 7	-	190	-	

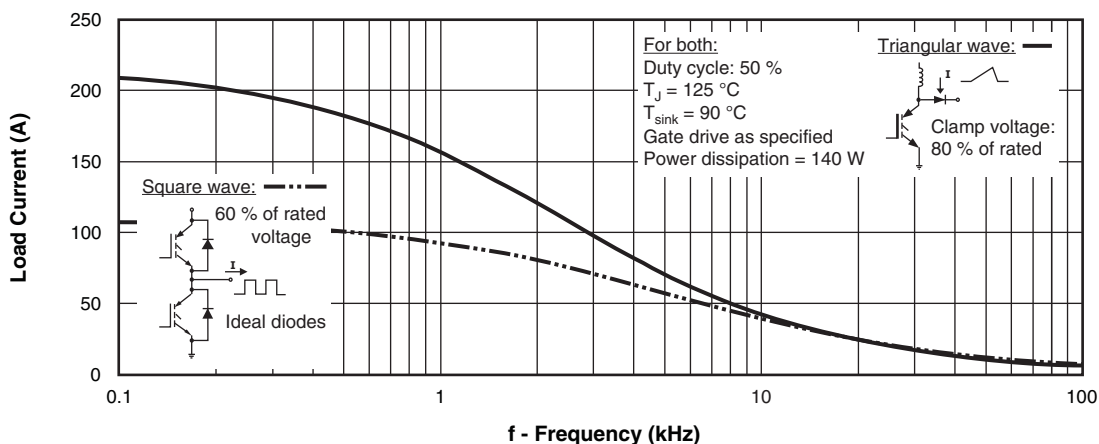


Fig. 1 - Typical Load Current vs. Frequency
(Load Current = I_{RMS} of Fundamental)

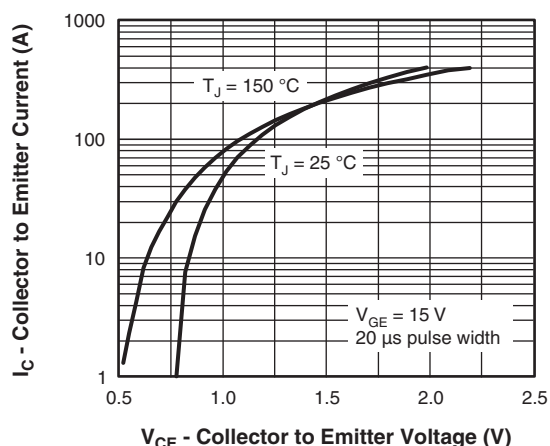


Fig. 2 - Typical Output Characteristics

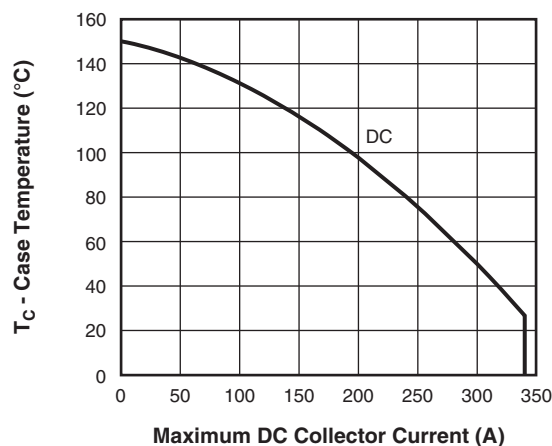


Fig. 4 - Maximum Collector Current vs. Case Temperature

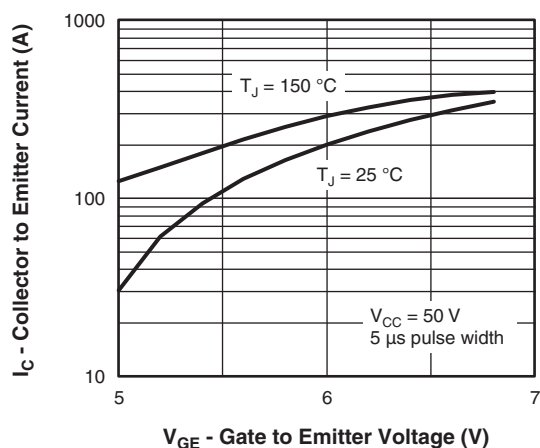


Fig. 3 - Typical Transfer Characteristics

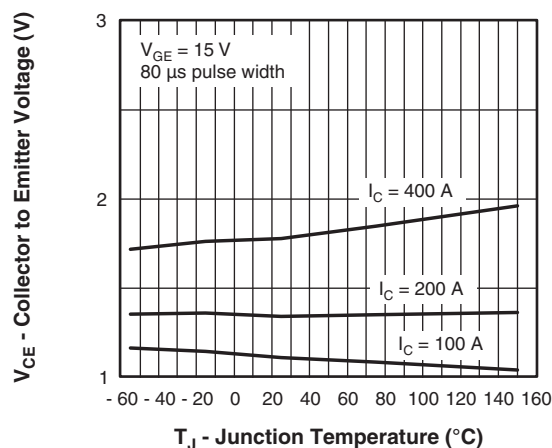


Fig. 5 - Typical Collector to Emitter Voltage vs. Junction Temperature

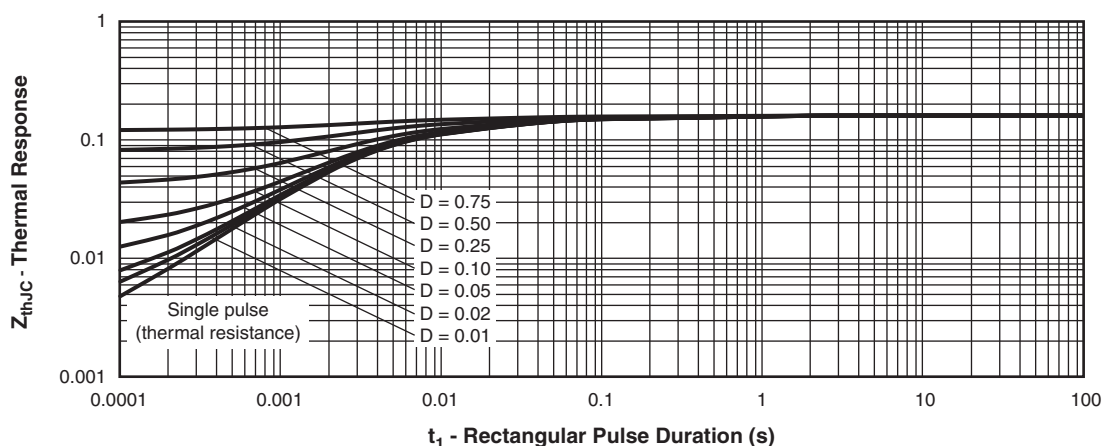


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction to Case

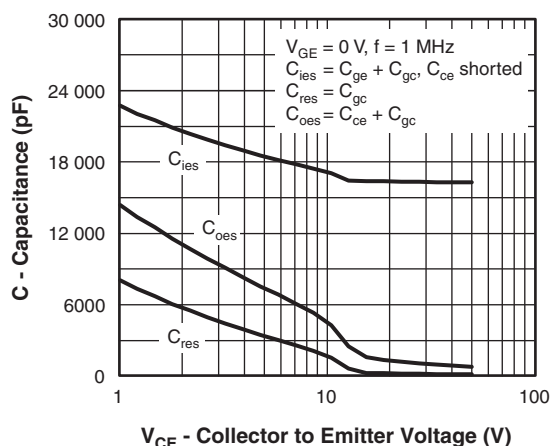


Fig. 7 - Typical Capacitance vs. Collector to Emitter Voltage

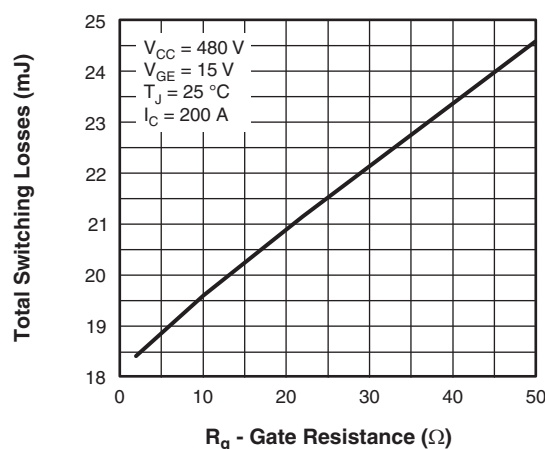


Fig. 9 - Typical Switching Losses vs. Gate Resistance

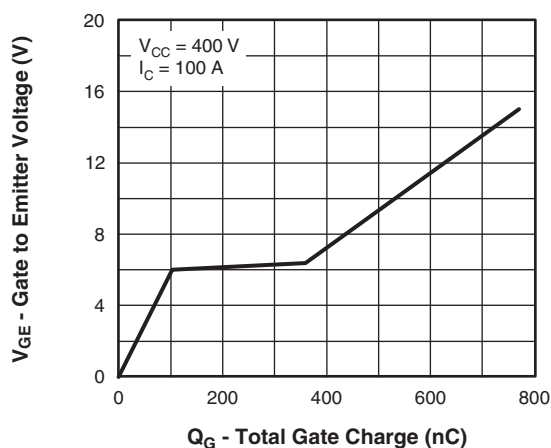


Fig. 8 - Typical Gate Charge vs. Gate to Emitter Voltage

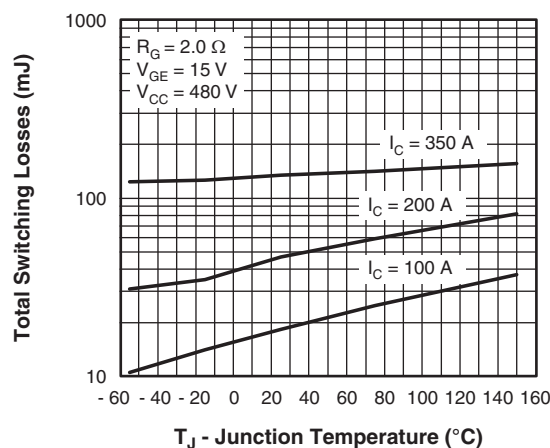


Fig. 10 - Typical Switching Losses vs. Junction Temperature

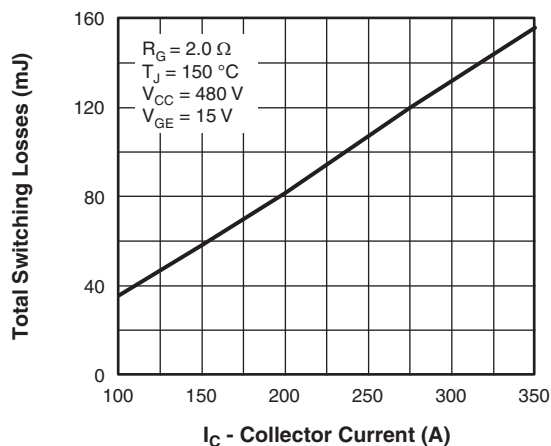
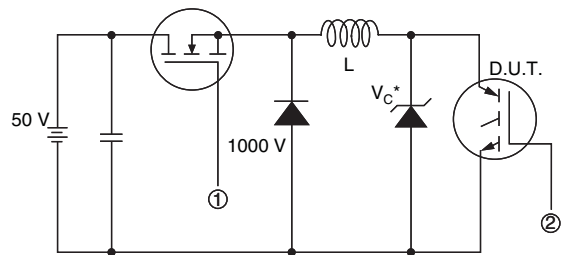


Fig. 11 - Typical Switching Losses vs. Collector Current



* Driver same type as D.U.T.; $V_C = 80\%$ of V_{CE} (max)

Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain rated I_d

Fig. 13a - Clamped Inductive Load Test Circuit

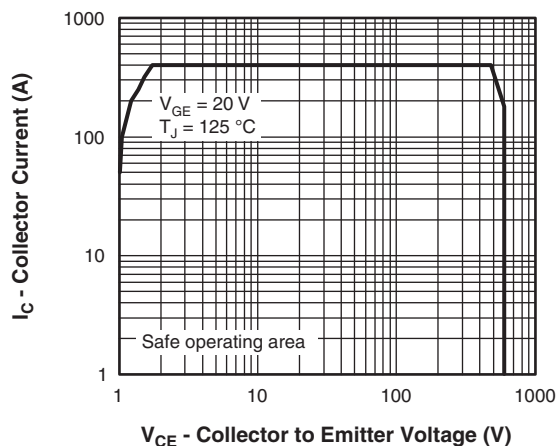


Fig. 12 - Turn-Off SOA

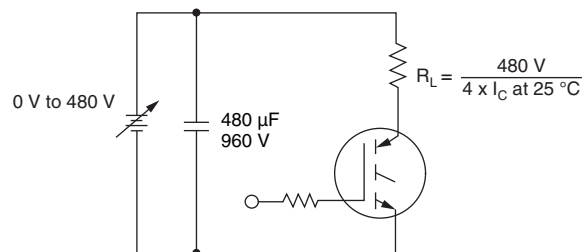
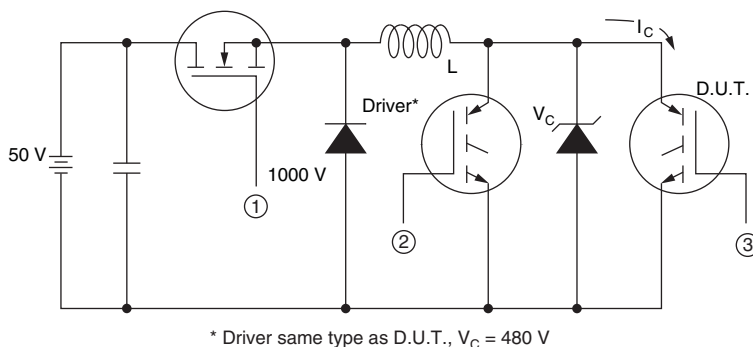


Fig. 13b - Pulsed Collector Current Test Circuit



* Driver same type as D.U.T., $V_C = 480$ V

Fig. 14a - Switching Lost Test Circuit

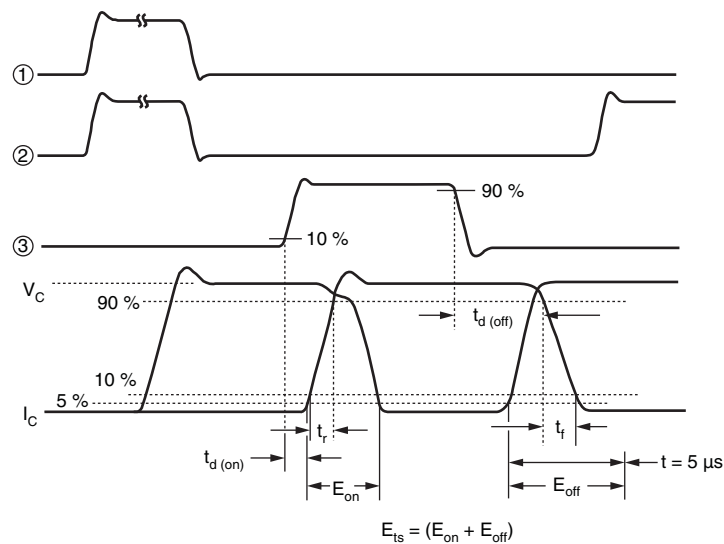


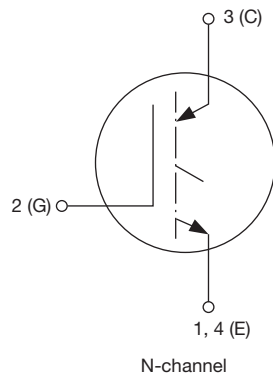
Fig. 14b - Switching Loss Waveforms

ORDERING INFORMATION TABLE

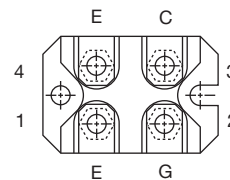
Device code	VS-	G	A	200	S	A	60	S	P
	①	②	③	④	⑤	⑥	⑦	⑧	⑨
①	-	Vishay Semiconductors product							
②	-	Insulated Gate Bipolar Transistor (IGBT)							
③	-	Generation 4, IGBT silicon, DBC construction							
④	-	Current rating (200 = 200 A)							
⑤	-	Single switch, no diode							
⑥	-	SOT-227							
⑦	-	Voltage rating (60 = 600 V)							
⑧	-	Speed/type (S = Standard speed)							
⑨	-	• None = Standard production • P = Lead (Pb)-free							



CIRCUIT CONFIGURATION



Lead assignment



LINKS TO RELATED DOCUMENTS

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95036
Packaging information	www.vishay.com/doc?95037

DIMENSIONS in millimeters (inches)



- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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